

FEATURES

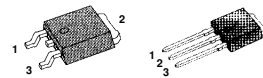
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 10 μ A (Max.) @ $V_{DS} = -60V$
- Lower $R_{DS(ON)}$: 0.22 Ω (Typ.)

$$BV_{DSS} = -60 V$$

$$R_{DS(on)} = 0.3 \Omega$$

$$I_D = -7.6 A$$

D-PAK I-PAK



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	-60	V
I_D	Continuous Drain Current ($T_C=25^\circ C$)	-7.6	A
	Continuous Drain Current ($T_C=100^\circ C$)	-5.4	
I_{DM}	Drain Current-Pulsed	30	A
V_{GS}	Gate-to-Source Voltage ①	± 20	V
E_{AS}	Single Pulsed Avalanche Energy ②	99	mJ
I_{AR}	Avalanche Current ①	-7.6	A
E_{AR}	Repetitive Avalanche Energy ①	3.2	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-5.5	V/ns
P_D	Total Power Dissipation ($T_A=25^\circ C$) *	2.5	W
	Total Power Dissipation ($T_C=25^\circ C$)	32	W
	Linear Derating Factor	0.26	W/ $^\circ C$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +150	$^\circ C$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	3.91	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient *	--	50	
$R_{\theta JA}$	Junction-to-Ambient	--	110	

* When mounted on the minimum pad size recommended (PCB Mount).

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	-60	--	--	V	$V_{GS}=0V, I_D=-250\mu A$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	-0.04	--	V/ $^\circ\text{C}$	$I_D=-250\mu A$ See Fig 7
$V_{GS(th)}$	Gate Threshold Voltage	-2.0	--	-4.0	V	$V_{DS}=-5V, I_D=-250\mu A$
I_{GSS}	Gate-Source Leakage, Forward	--	--	-100	nA	$V_{GS}=-20V$
	Gate-Source Leakage, Reverse	--	--	100		$V_{GS}=20V$
I_{DSS}	Drain-to-Source Leakage Current	--	--	-10	μA	$V_{DS}=-60V$
		--	--	-100		$V_{DS}=-48V, T_C=125^\circ\text{C}$ ④
$R_{DS(on)}$	Static Drain-Source On-State Resistance	--	--	0.3	Ω	$V_{GS}=-10V, I_D=-3.8A$
g_{fs}	Forward Transconductance	--	3.6	--	Ω	$V_{DS}=-30V, I_D=-3.8A$ ④
C_{iss}	Input Capacitance	--	465	600	pF	$V_{GS}=0V, V_{DS}=-25V, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	--	140	215		
C_{rss}	Reverse Transfer Capacitance	--	40	60		
$t_{d(on)}$	Turn-On Delay Time	--	11	30	ns	$V_{DD}=-30V, I_D=-9.4A,$ $R_G=18\Omega$ See Fig 13 ④⑤
t_r	Rise Time	--	21	50		
$t_{d(off)}$	Turn-Off Delay Time	--	29	65		
t_f	Fall Time	--	20	50		
Q_g	Total Gate Charge	--	15	19	nC	$V_{DS}=-48V, V_{GS}=-10V,$ $I_D=-9.4A$ See Fig 6 & Fig 12 ④⑤
Q_{gs}	Gate-Source Charge	--	2.9	--		
Q_{gd}	Gate-Drain("Miller") Charge	--	6.0	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	--	--	-7.6	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	-30		
V_{SD}	Diode Forward Voltage ④	--	--	-3.8	V	$T_J=25^\circ\text{C}, I_S=-7.6A, V_{GS}=0V$
t_{rr}	Reverse Recovery Time	--	80	--	ns	$T_J=25^\circ\text{C}, I_F=-9.4A$
Q_{rr}	Reverse Recovery Charge	--	0.22	--	μC	$di_F/dt=100A/\mu\text{s}$ ④

Notes ;

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=2.0\text{mH}, I_{AS}=-7.6A, V_{DD}=-25V, R_G=27\Omega^*,$ Starting $T_J=25^\circ\text{C}$
- ③ $I_{SD} \leq -9.4A, di/dt \leq 250A/\mu\text{s}, V_{DD} \leq BV_{DSS},$ Starting $T_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = 250 μs , Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

Fig 1. Output Characteristics

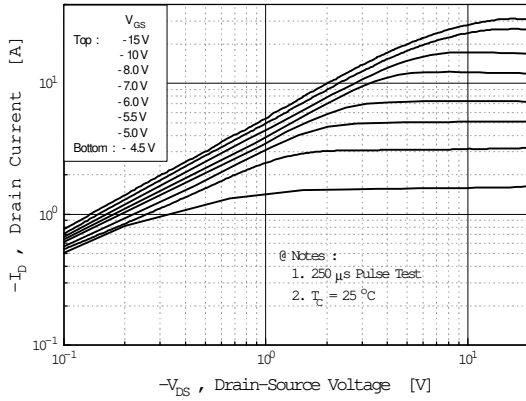


Fig 2. Transfer Characteristics

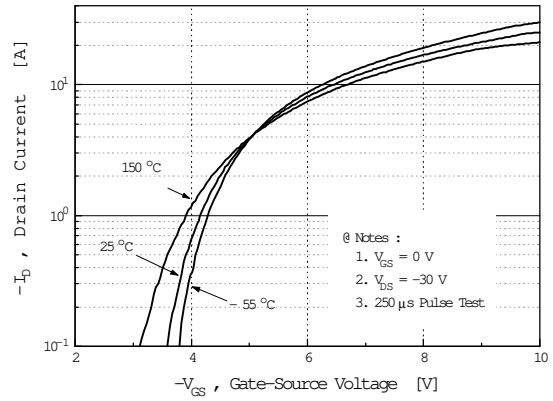


Fig 3. On-Resistance vs. Drain Current

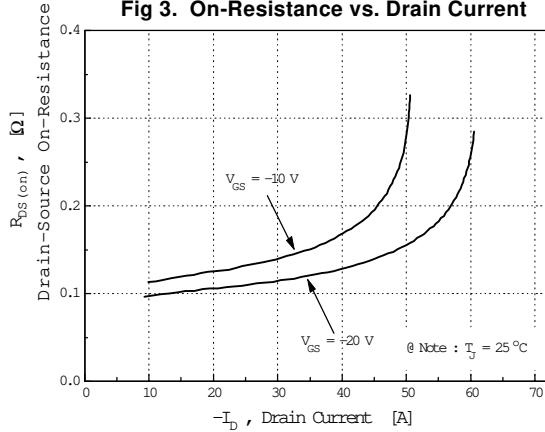


Fig 4. Source-Drain Diode Forward Voltage

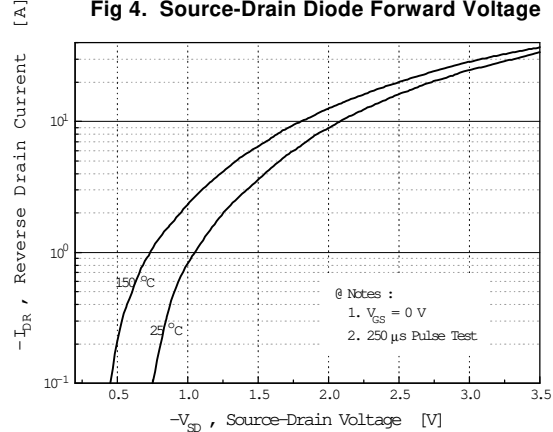


Fig 5. Capacitance vs. Drain-Source Voltage

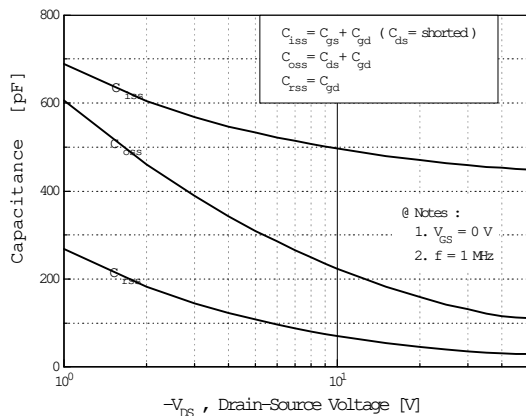
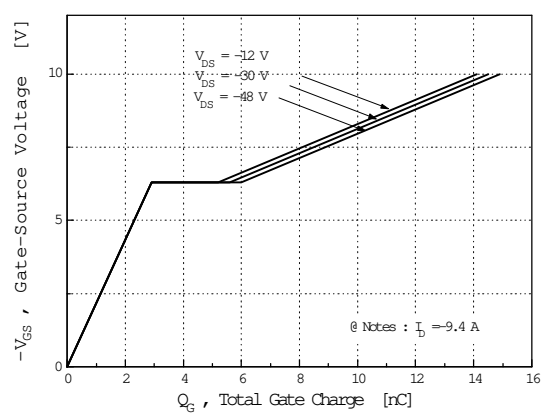


Fig 6. Gate Charge vs. Gate-Source Voltage



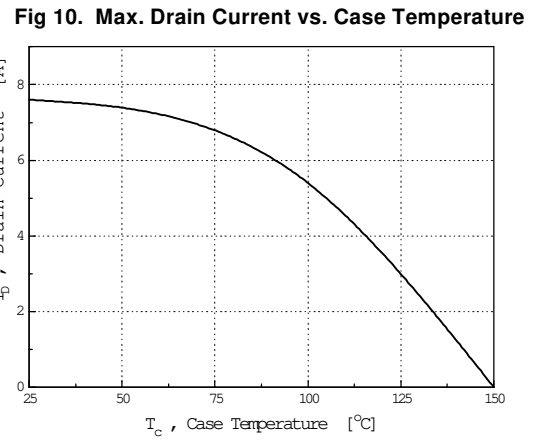
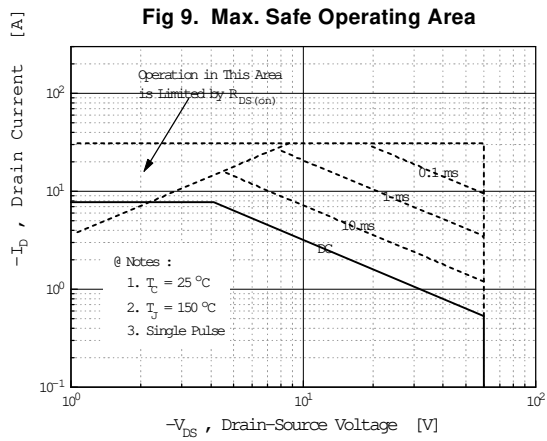
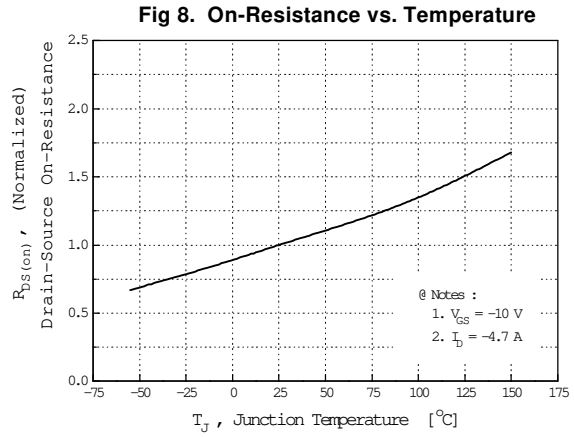
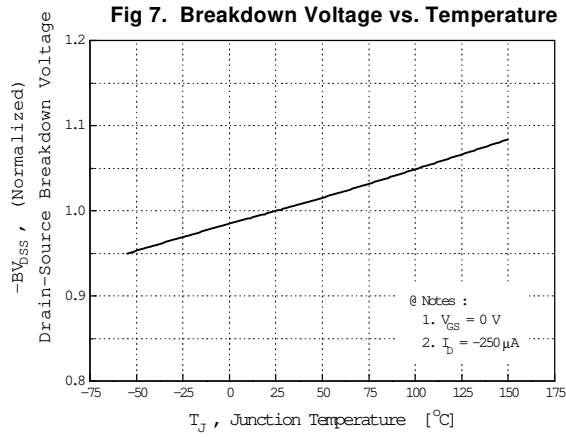


Fig 11. Thermal Response

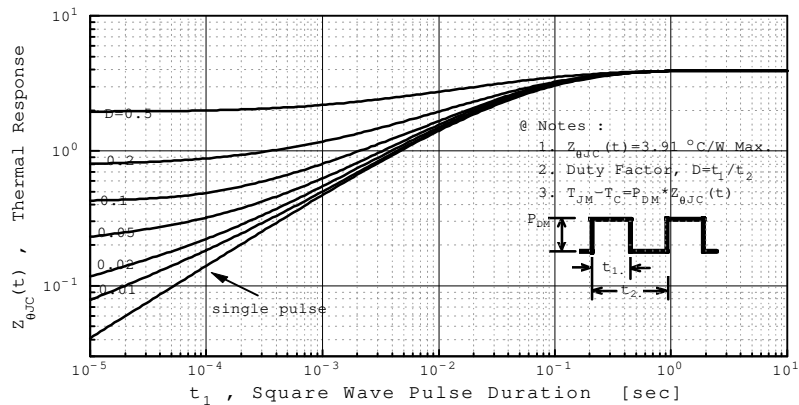


Fig 12. Gate Charge Test Circuit & Waveform

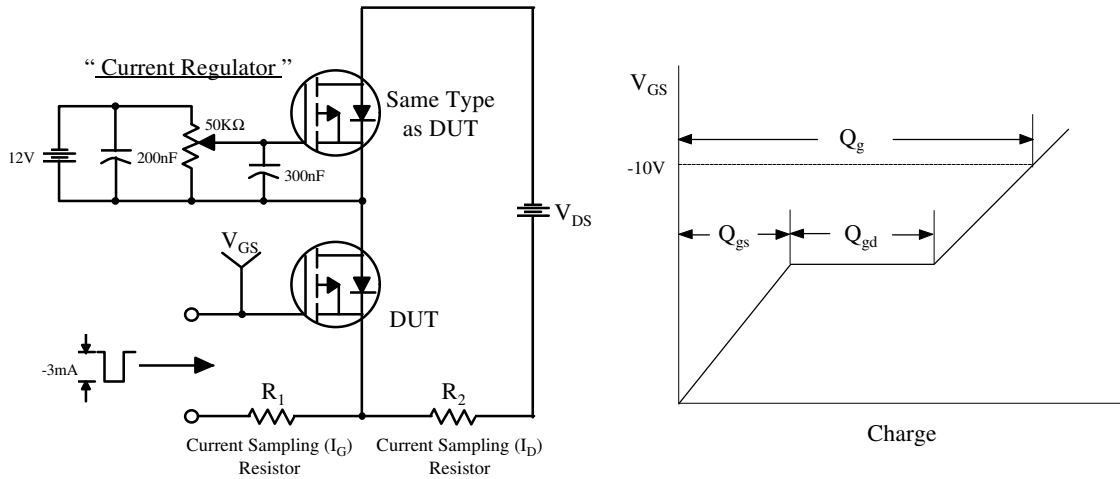


Fig 13. Resistive Switching Test Circuit & Waveforms

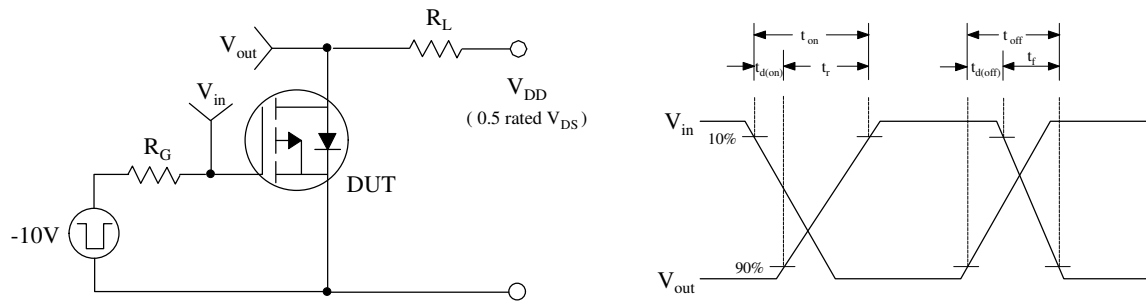


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

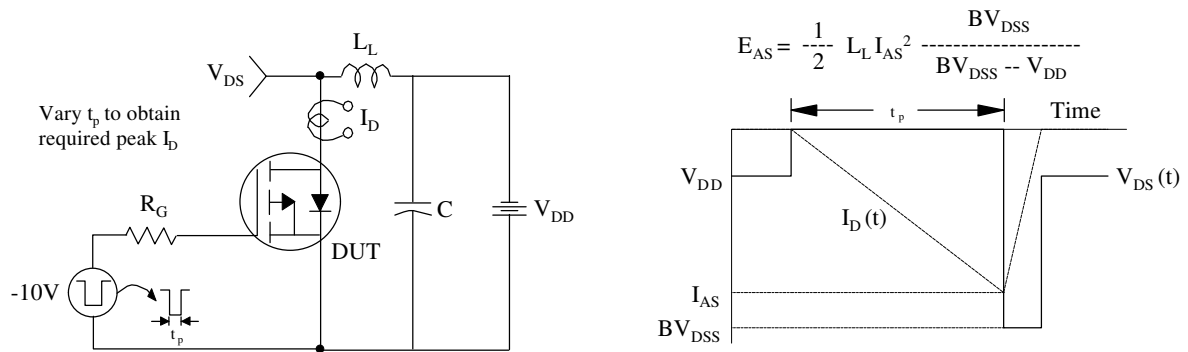
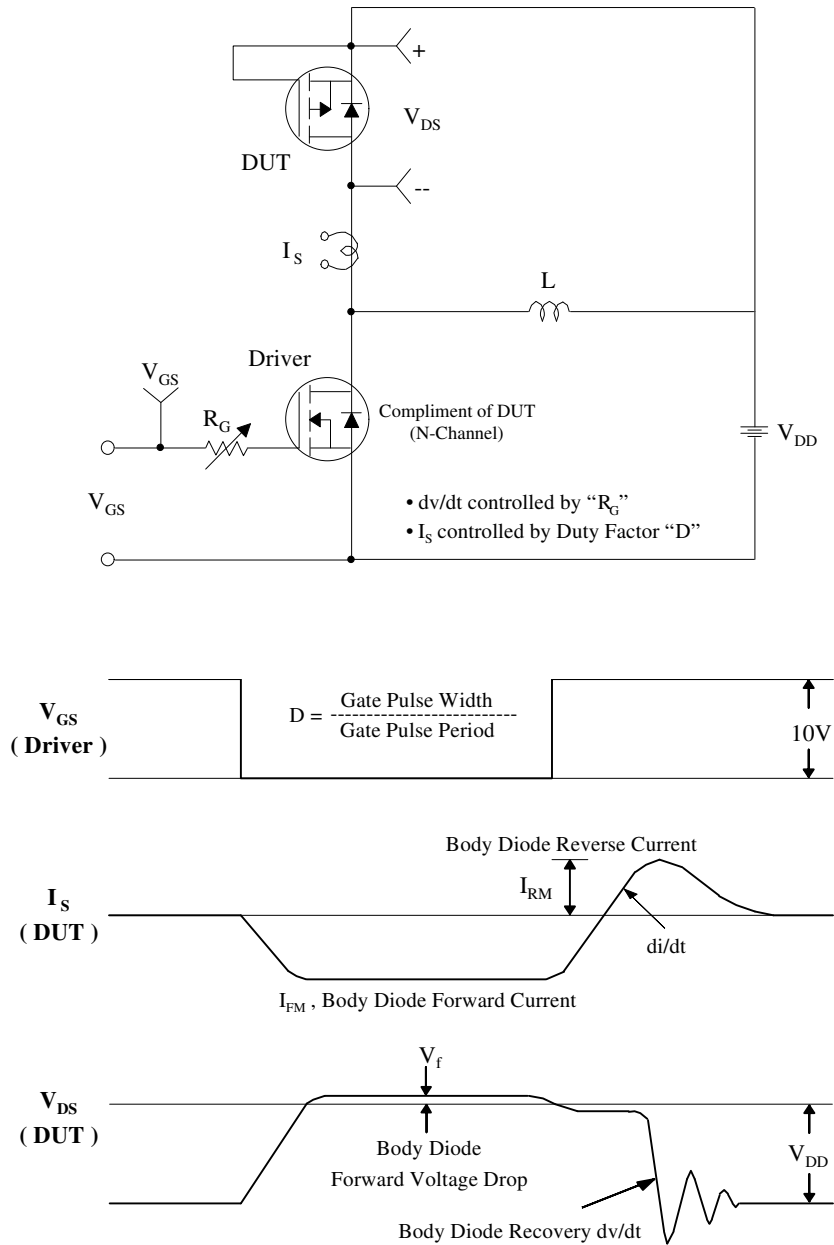


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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SFU2955
60V P-Channel A-FET

Contents
[Product status/pricing/packaging](#)

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This page
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Product	Product status	Pricing*	Package type	Leads	Packing method
SFU2955TU	Full Production	\$0.413	TO-251(IPAK)	3	RAIL

* 1,000 piece Budgetary Pricing

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- [Memory](#)
- [Optoelectronics](#)
- [Markets and applications](#)
- [New products](#)
- [Product selection and parametric search](#)
- [Cross-reference search](#)

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[Contents](#)
[Product status/pricing/package](#)

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SFR2955TF	Full Production	\$0.413	TO-252(DPAK)	2	TAPE REEL
SFR2955TM	Full Production	\$0.413	TO-252(DPAK)	2	TAPE REEL

* 1,000 piece Budgetary Pricing

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